MOS Field Effect Transistor
2SK3899
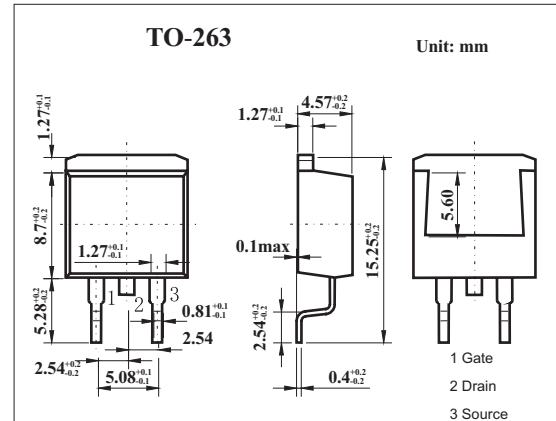
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TO-263                        Unit: mm
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■ Features

● Low On-state resistance

$R_{DS(on)1}$ = 5.3mΩ MAX. (V_{GS} = 10 V, I_D = 42 A)

$R_{DS(on)2}$ = 6.5 mΩ MAX. (V_{GS} = 4.5 V, I_D = 42 A)

● Low C_{iss}: C_{iss} = 5500 pF TYP.

■ Absolute Maximum Ratings Ta = 25℃

Parameter	Symbol	Rating	Unit
Drain to source voltage	V_{DSS}	60	V
Gate to source voltage	V_{GSS}	±20	V
Drain current	I_D	±84	A
	I_{dp} *	±336	A
Power dissipation T_A=25℃	P_D	1.5	W
T_C=25℃		146	
Channel temperature	T_{ch}	150	℃
Storage temperature	T_{stg}	-55 to +150	℃

* PW≤10μs,Duty Cycle≤1%

■ Electrical Characteristics Ta = 25℃

Parameter	Symbol	Testconditons	Min	Typ	Max	Unit
Drain cut-off current	I_{DSS}	V_{DS}=60V,V_{GS}=0			10	μA
Gate leakage current	I_{GSS}	V_{GS}=±20V,V_{DS}=0			±10	μA
Gate cut off voltage	$V_{GS(off)}$	V_{DS}=10V,I_D=1mA	1.5	2.0	2.5	V
Forward transfer admittance	|Y_{fs}|	V_{DS}=10V,I_D=42A	35	70		S
Drain to source on-state resistance	$R_{DS(on)1}$	V_{GS}=10V,I_D=42A		4.2	5.3	mΩ
	$R_{DS(on)2}$	V_{GS}=4.5V,I_D=42A		4.9	6.5	mΩ
Input capacitance	C_{iss}	V_{DS}=10V,V_{GS}=0,f=1MHZ		5500		pF
Output capacitance	C_{oss}			1050		pF
Reverse transfer capacitance	C_{rss}			350		pF
Turn-on delay time	t_{on}	I_D=42A,$V_{GS(on)}$=10V,R_G=0Ω,V_{DD}=30V		19		ns
Rise time	t_r			13		ns
Turn-off delay time	t_{off}			91		ns
Fall time	tf			10		ns
Total Gate Charge	Q_G	V_{DD} = 48V		96		nC
Gate to Source Charge	Q_{GS}	V_{GS} = 10 V		18		nC
Gate to Drain Charge	Q_{GD}	I_D =84A		23.5		nC